

10/050014
01/17/02

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPLICATION NUMBER	FILING DATE	CLASS	SUBCLASS	GROUP ART UNIT	EXAMINER
APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10050014	01/17/2002	205	22	1741	

****APPLICANTS:** Khaselev Oscar; Zavarine Igor; Zhang Yun;

****CONTINUING DATA VERIFIED:**

**** FOREIGN APPLICATIONS VERIFIED:**

PG-PUB ☐ DO NOT PUBLISH ☐ RESCIND ☐

Foreign priority claimed ☐ yes ☐ no
35 USC 119 conditions met ☐ yes ☐ no
Verified and Acknowledged Examiners's initials

ATTORNEY DOCKET NO
KHASELEV 2-2-28

TITLE : Electroplating solution for high speed plating of tin-bismuth solder

U.S. DEPT. OF COMM./PAT & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED	
ISSUE FEE			Total Claims	Print Claim for O.G.
Amount Due	Date Paid	Primary Examiner	DRAWING	
			Sheets Drwg.	Figs. Drwg.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner	
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